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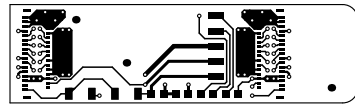
B

C

C

D

D



Top Layer

PHYSIK INSTITUT

UNIVERSITAET ZUERICH
WINTERTHURERSTR 190
CH-8057 ZUERICH
SWITZERLAND

SYSTEM:
CMS LEA TESTING

BOARD NAME:
ADAPTER_L2_L2

CREATED:
12-JAN-2016, DANIEL FLORIN

BOARD NUMBER:
PCB160112

MODIFIED:
12-JAN-2016, DANIEL FLORIN

REVISION:
1.0

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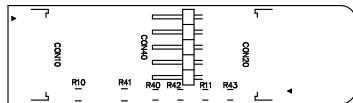
B

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Top Overlay
 (Top Silkscreen Legend, printed on PCB)

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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Top Paste

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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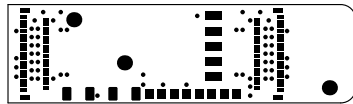
B

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Top Solder

PHYSIK INSTITUT

UNIVERSITAET ZUERICH
WINTERTHURERSTR 190
CH-8057 ZUERICH
SWITZERLAND

SYSTEM:
CMS LEA TESTING

BOARD NAME:
ADAPTER_L2_L2

BOARD NUMBER:
PCB160112

REVISION:
1.0

CREATED:
12-JAN-2016, DANIEL FLORIN

MODIFIED:
12-JAN-2016, DANIEL FLORIN

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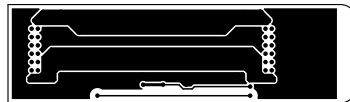
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MidLayer 1

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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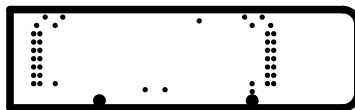
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InternalPlane 1

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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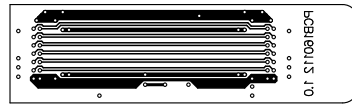
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Bottom Layer

PHYSIK INSTITUT

UNIVERSITAET ZUERICH
WINTERTHURERSTR 190
CH-8057 ZUERICH
SWITZERLAND

SYSTEM:
CMS LEA TESTING

BOARD NAME:
ADAPTER_L2_L2

CREATED:
12-JAN-2016, DANIEL FLORIN

BOARD NUMBER:
PCB160112

MODIFIED:
12-JAN-2016, DANIEL FLORIN

REVISION:
1.0

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Bottom Overlay
 (Bottom Silkscreen Legend, NOT printed on PCB)

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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Bottom Paste

PHYSIK INSTITUT

UNIVERSITAET ZUERICH
WINTERTHURERSTR 190
CH-8057 ZUERICH
SWITZERLAND

SYSTEM:
CMS LEA TESTING

BOARD NAME:
ADAPTER_L2_L2

BOARD NUMBER:
PCB160112

REVISION:
1.0

CREATED:
12-JAN-2016, DANIEL FLORIN

MODIFIED:
12-JAN-2016, DANIEL FLORIN

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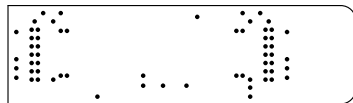
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Bottom Solder

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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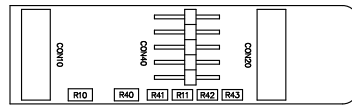
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Top Assembly Drawing
 (Top Assembly Legend, NOT printed on PCB)

PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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Bottom Assembly Drawing
 (Bottom Assembly Legend, NOT printed on PCB)

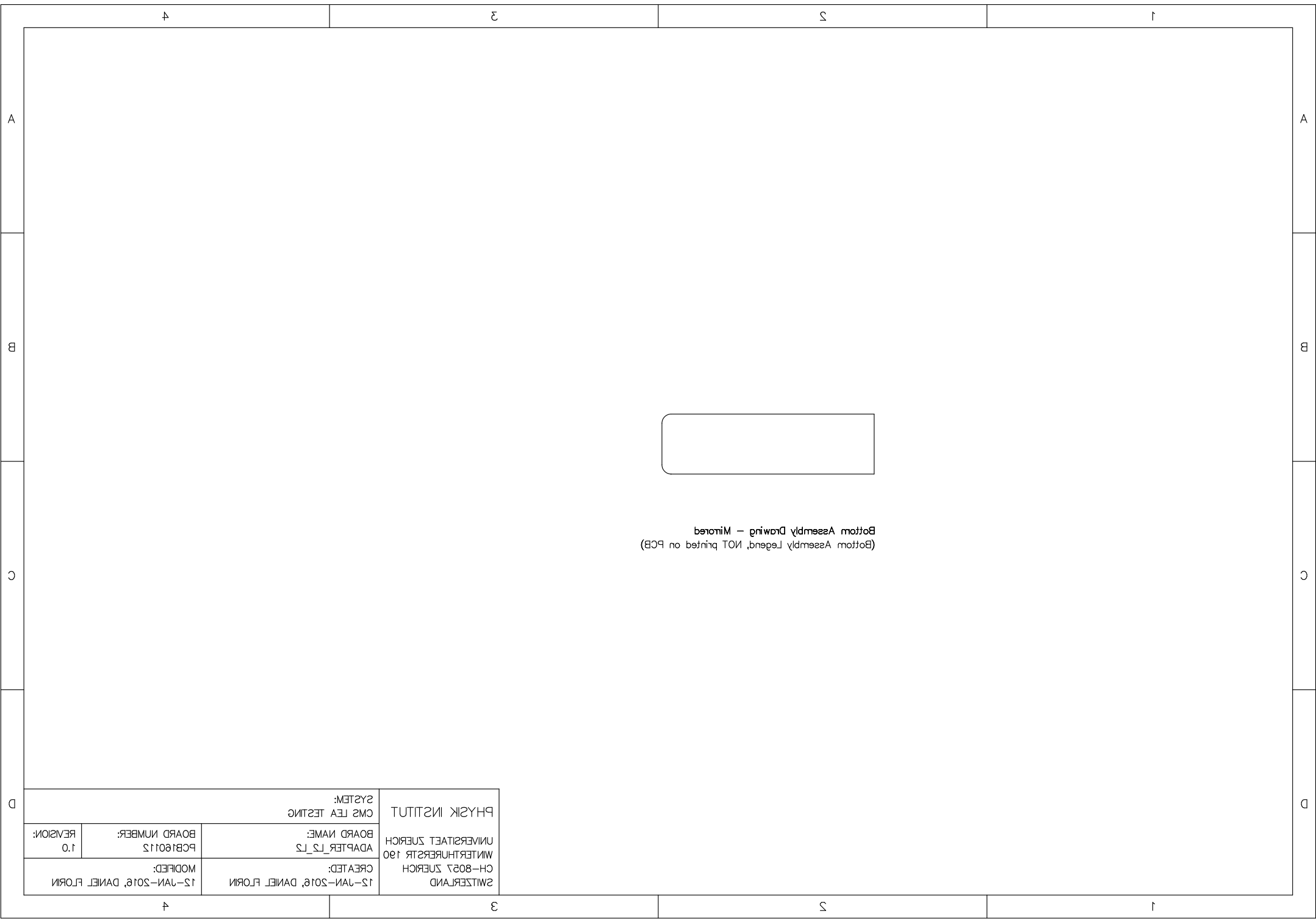
PHYSIK INSTITUT UNIVERSITAET ZUERICH WINTERTHURERSTR 190 CH-8057 ZUERICH SWITZERLAND	SYSTEM: CMS LEA TESTING		
	BOARD NAME: ADAPTER_L2_L2	BOARD NUMBER: PCB160112	REVISION: 1.0
	CREATED: 12-JAN-2016, DANIEL FLORIN	MODIFIED: 12-JAN-2016, DANIEL FLORIN	

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Bottom Assembly Legend, NOT printed on PCB)
 Bottom Assembly Drawing – Mirrored

12-JAN-2016, DANIEL FLORIN		12-JAN-2016, DANIEL FLORIN	
MODIFIED:	CREATED:	CH-8052 ZUERICH	SWITZERLAND
PCB160112		WINTERTHURSTR 190	
BOARD NUMBER:	ADAPTER_L2_L2	UNIVERSITAET ZUERICH	
REVISION: 1.0	PHYSIK INSTITUT		
CMS LEA TESTING		SYSTEM:	

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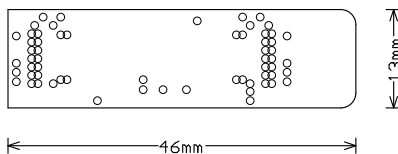
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PCB Fabrication Drawing

Top Silkscreen Legend: Yes
 Top Soldermask: Green
 Top Surface Finish: NiAu (ENIG)

Top Layer, Copper Weight 35um (Finished)
Prepreg, 300um
Mid-Layer 1, Copper Weight 35um (Finished)
Prepreg, 360um
Internal Plane 1, Copper Weight 35um (Finished)
Prepreg, 300um
Bottom Layer, Copper Weight 35um (Finished)

Bottom Surface Finish: NiAu (ENIG)
 Bottom Soldermask: Green
 Bottom Silkscreen Legend: No

Total approx. 1100um

Layer Stack (4-Layers Multilayer)

Symbol	Hit Count	Tool Size	Plated	Hole Type
o	62	0.3mm (11.811mil)	PTH	Round
	62 Total			

Drill Drawing

PHYSIK INSTITUT

UNIVERSITAET ZUERICH
WINTERTHURERSTR 190
CH-8057 ZUERICH
SWITZERLAND

SYSTEM:
CMS LEA TESTING

BOARD NAME:
ADAPTER_L2_L2

BOARD NUMBER:
PCB160112

REVISION:
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CREATED:
12-JAN-2016, DANIEL FLORIN

MODIFIED:
12-JAN-2016, DANIEL FLORIN

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